

Creative Materials, Inc. 12 Willow Road Ayer, MA 01432 ISO 9001 CERTIFIED

T 978.391.4700 F 978.391.4705

121-41

CARBON FILLED, POLYIMIDE BASED, CONDUCTIVE INK FOR PRINTED RESISTORS AND POTENTIOMETERS

<u>DESCRIPTION</u>: 121-41 is a high temperature resistant, carbon filled, polyimide based, electrically conductive ink/coating for application by screen-printing, dipping and syringe dispensing. The product features excellent adhesion to FR-4 board, polyimide film, ceramic, glass and a variety of other rigid substrates. Unlike conventional conductive materials, this product is very resistant to abrasion and scratching. Some applications for 121-41 include, but are not limited to, printed resistors, potentiometers and polymer thick film circuitry.

TYPICAL PROPERTIES:

Viscosity (cps) 20,000 - 25,000

Filler Carbon Volume Resistance (Ω -cm) 0.025 Sheet Resistivity (Ω /square/mil) 10

Hydrolytic Stability Excellent
Useful Temperature Range (°C) -55 to 360

SUGGESTED HANDLING & CURING: 121-41 is ready to use as supplied. Further thinning may be accomplished by adding CMI#121-42 thinner. Prior to use, be certain to mix well to re-suspend filler. For most applications, very good properties result when cured for 1 hour at 200°C.

For optimum product performance, a 3-step curing process is recommended. Initially, cure 1 hour at 200°C followed by 1 hour at 300°C with a final cure of 1 hour at 325°C.

Good properties are also obtained on a variety of substrates by curing for 30 minutes at 175°C. End user is advised to experimentally determine temperature and time best suited for individual applications.

STORAGE: Shelf life: 2 weeks at 25°C; 6 months at -10°C.

SAFETY & HANDLING: Use with adequate ventilation. Keep away from sparks and open flames. Avoid prolonged contact with skin and breathing of vapors. Wash with soap and water to remove from skin.

All technical information is based on data obtained by CMI personnel and is believed to be reliable. No warranty is either expressed or implied with respect to results or possible infringements on patents.

REVISION DATE: 6/11/08 REVISION: D